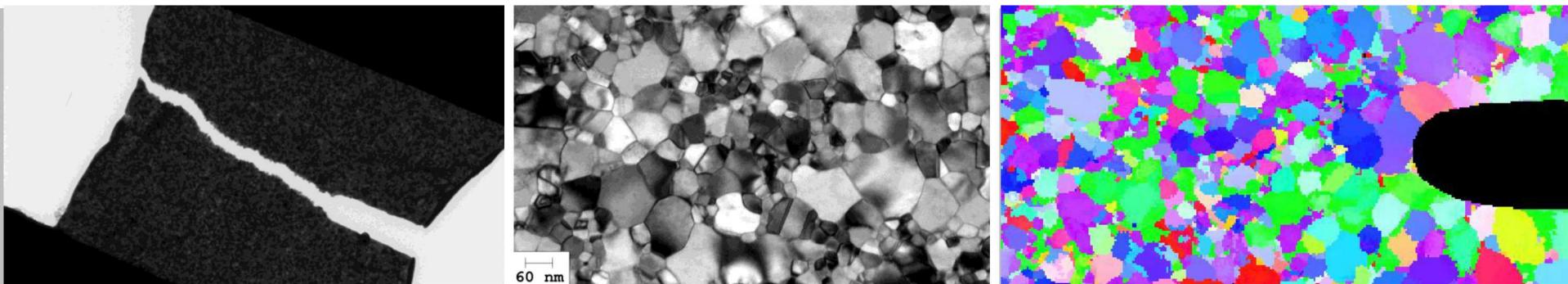


Exceptional service in the national interest



Exploring Grain Boundary Dependent Deformation Mechanisms in Nanocrystalline Materials Through In-situ TEM High Cycle Fatigue

Christopher M. Barr and Khalid Hattar

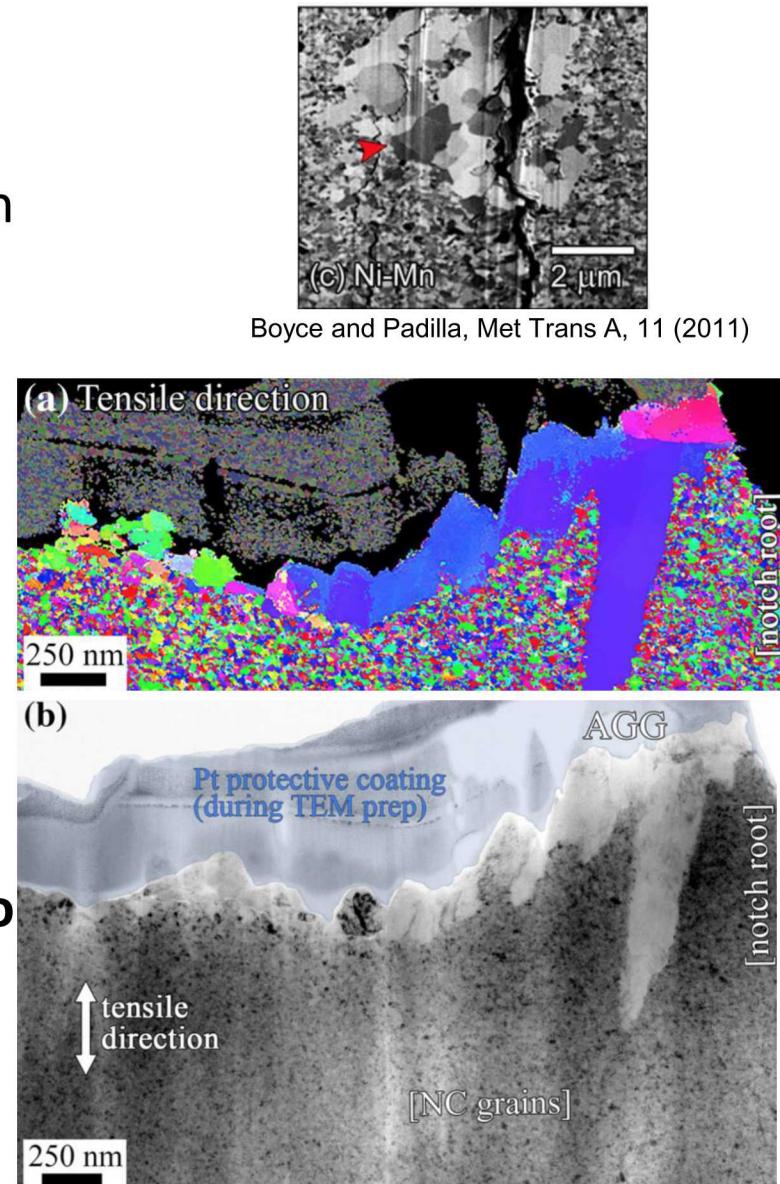
Sandia National Laboratories



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Nanocrystalline Alloys: Fatigue and Fracture

- Improved fatigue endurance limit compared to coarse grain counterparts
- Progressive microstructural changes with cyclic loading, often below yield stress
- Fatigue in nanocrystalline metals
 - Grain boundary migration and grain growth
 - Crack initiation
- What are the underlying mechanisms associated with these phenomena?
- ***In situ* TEM deformation techniques provide the spatial resolution needed to investigate these questions**
- Ideally coupled with bulk scale testing



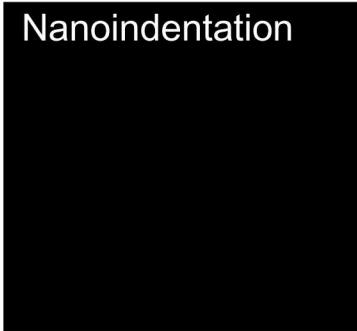
In situ Quantitative Mechanical Testing



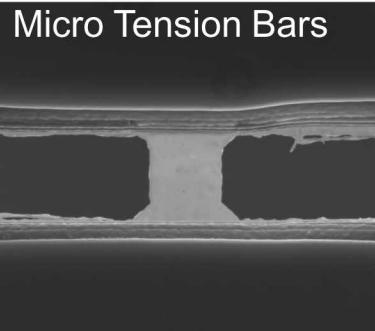
Hysitron PI95 In Situ Nanoindentation TEM Holder

- **Sub nanometer displacement resolution**
- **Quantitative force information with μN resolution**
- **Concurrent real-time imaging**

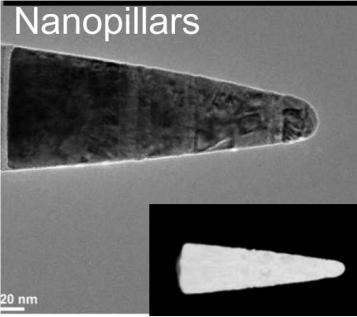
Nanoindentation



Micro Tension Bars



Nanopillars

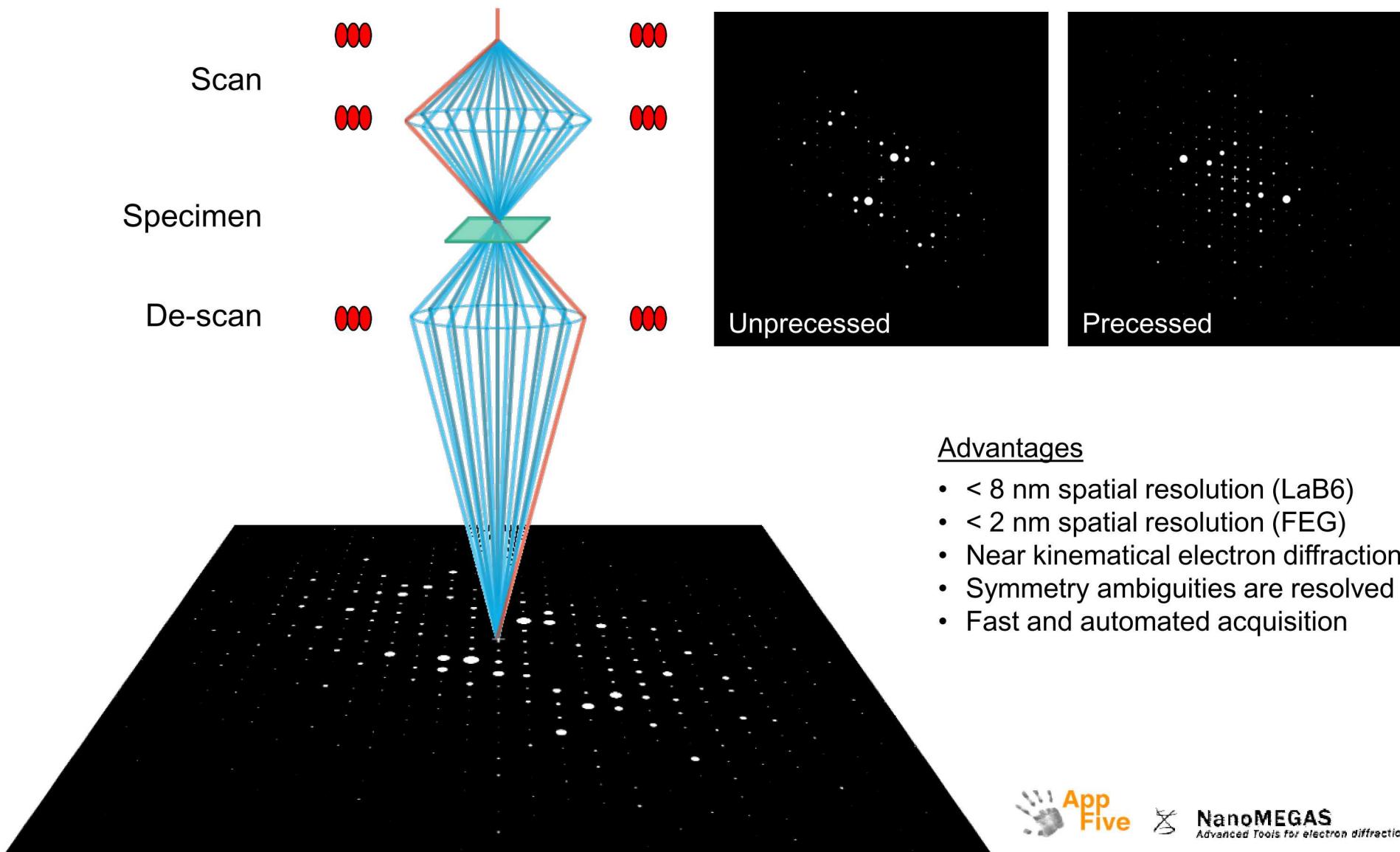


Notched Bar



- **A variety of sample geometries**
- **Load functions examined at I³TEM:**
 - 1) Indentation
 - 2) Tension
 - 3) Fatigue
 - 4) Creep (irradiation and thermal)
 - 5) Compression
 - 6) Future: Nanowear

Precession Electron Diffraction (PED) Microscopy

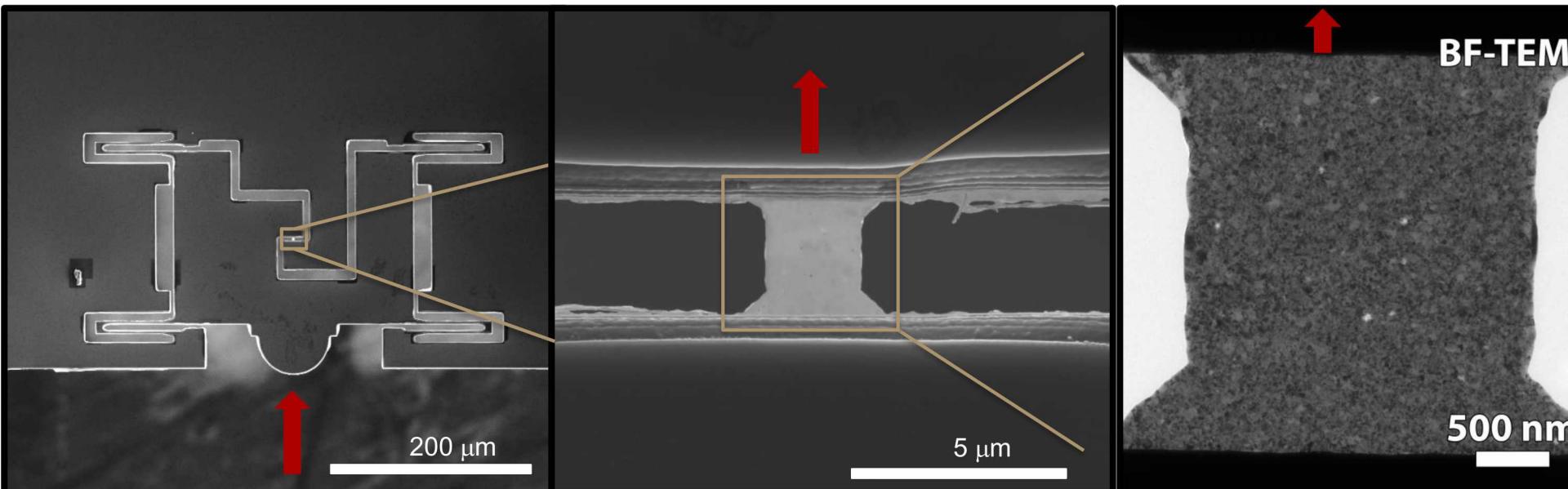


Advantages

- < 8 nm spatial resolution (LaB6)
- < 2 nm spatial resolution (FEG)
- Near kinematical electron diffraction
- Symmetry ambiguities are resolved
- Fast and automated acquisition

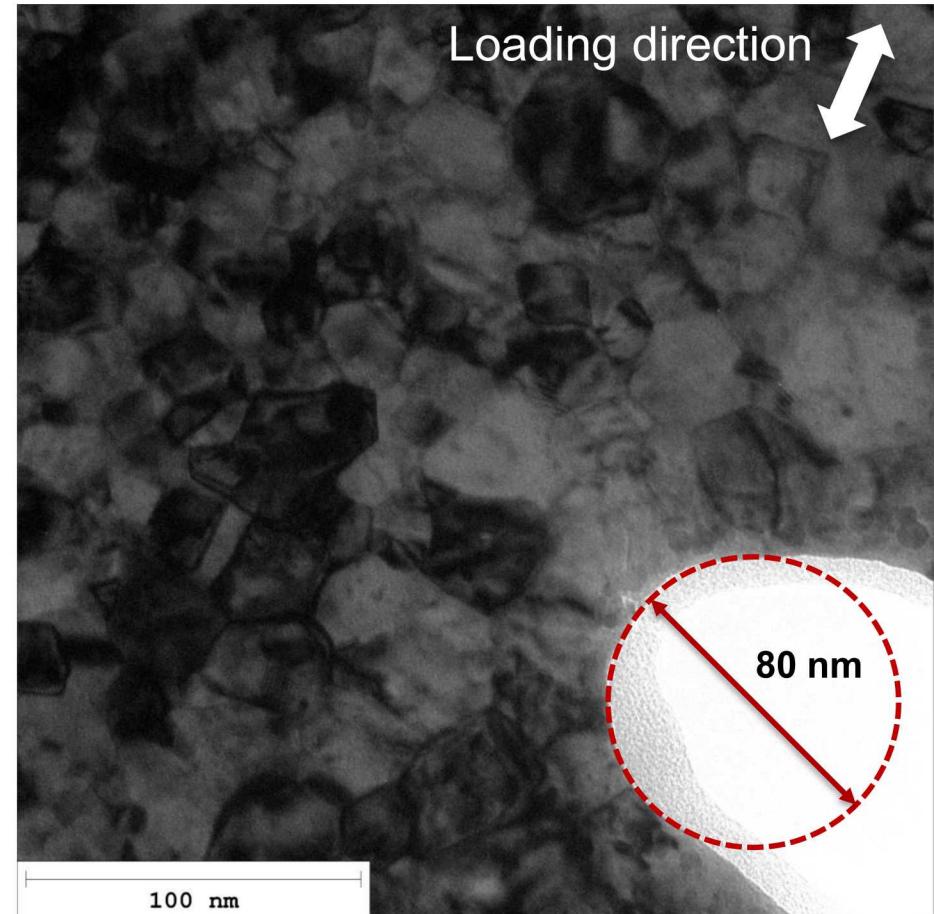
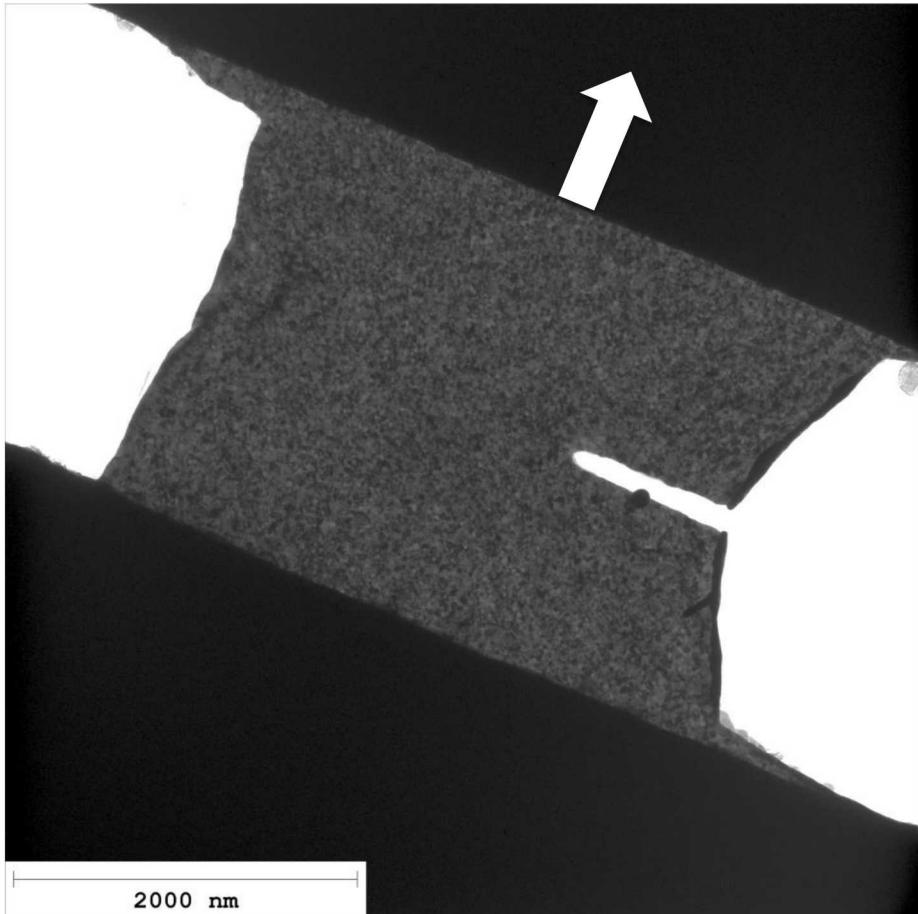
Tension Specimen Fabrication

- Hysitron “Push-to-Pull” devices
 - Microfabricated Si test frame
 - Pt film (40nm) floated onto device, then FIB milled. Final FIB cut: minimize I-beam imaging → minimize Ga
 - Notched test → improved “chance” of observing crack initiation and propagation



- Nearly pure tension, uniform cross sectional area, stable load frame
- Sensitive to shape of edges, issues with magnetic materials
- $F_{applied} = F_{measured} - F_{spring}$

Notched NC Pt: In-situ Cyclic Loading/Fatigue

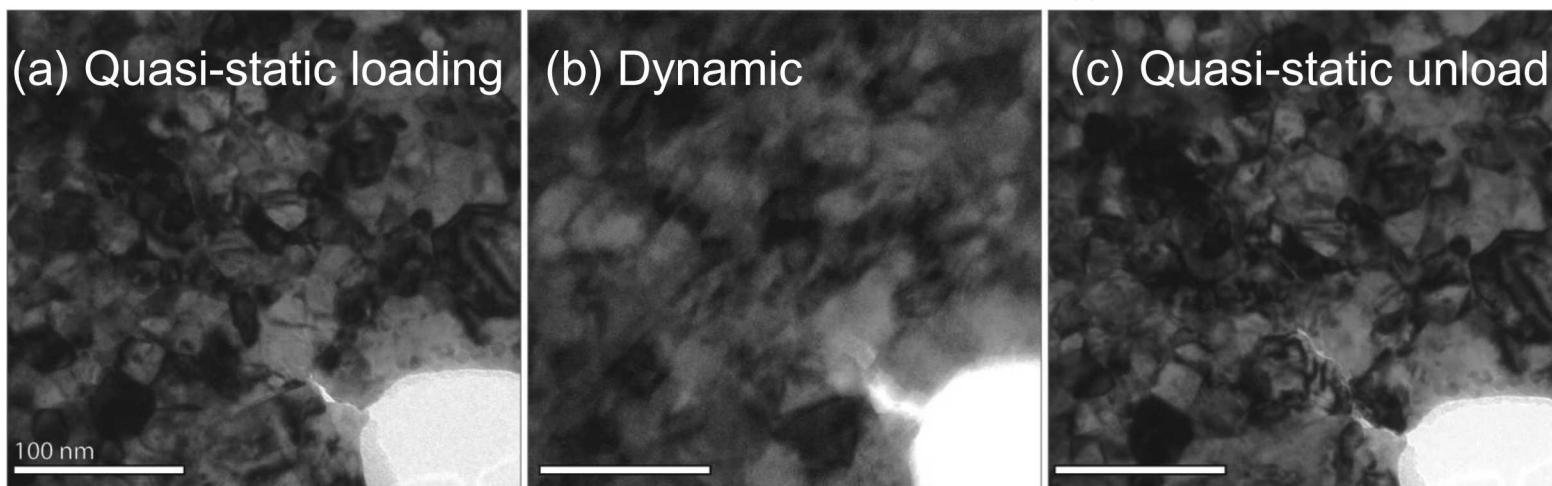
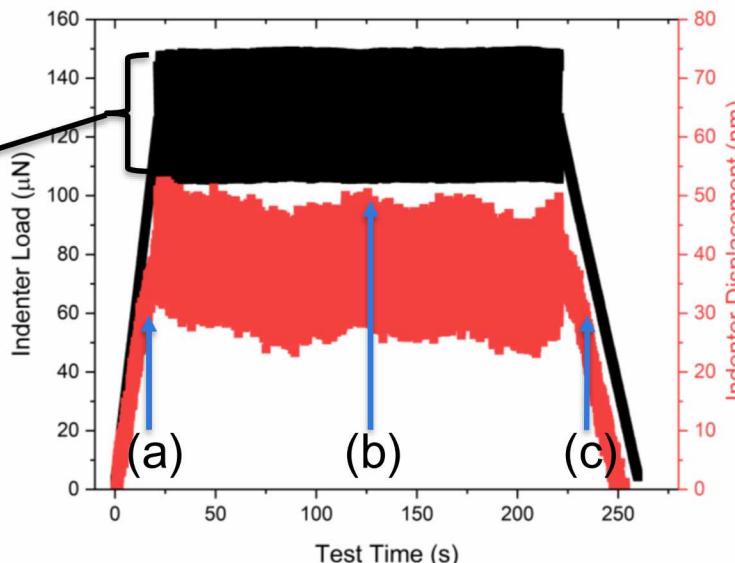


- Notch length = 950 nm, Gauge width = 3.3 μ m
- Notch created by FIB “line”

Methodology: Cyclic Loading in TEM Protocol

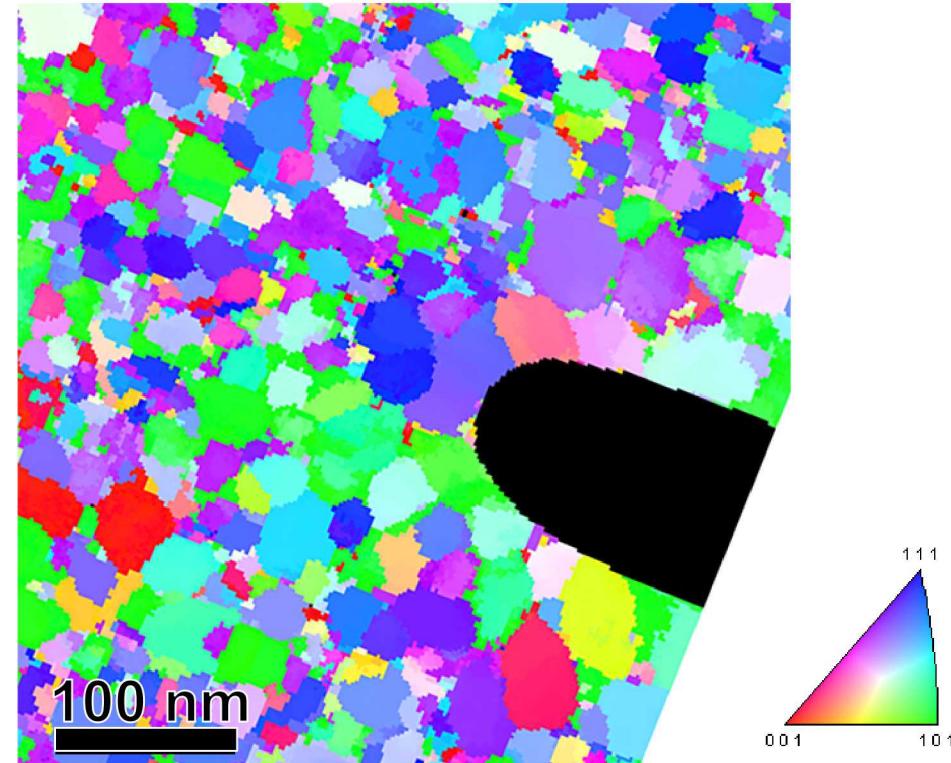
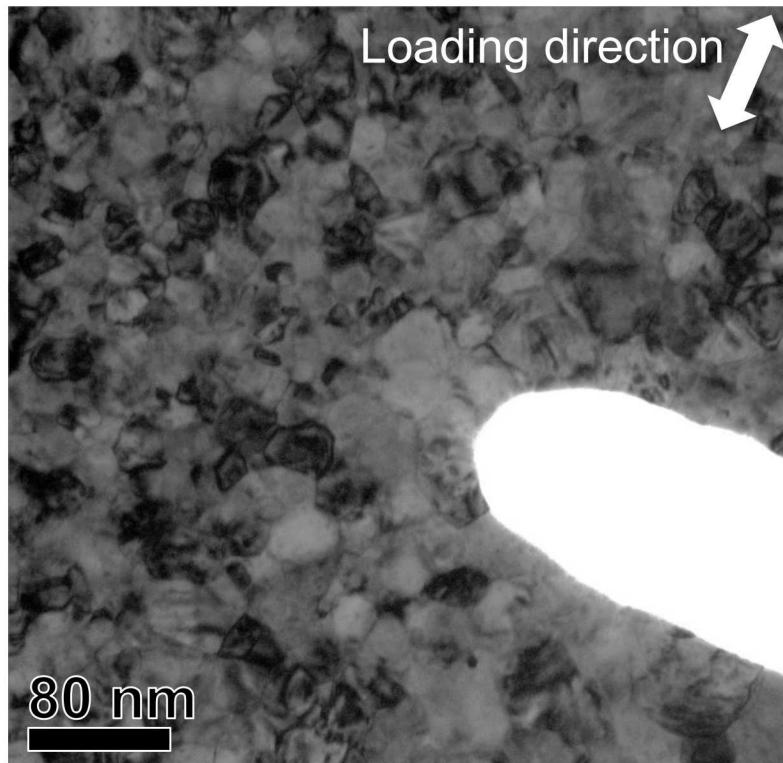
Mean load (P_{mean}) = 135 μN

Amplitude load (P_{amp}) = 35 μN



- Motion blur \rightarrow loading frequency exceeded the frame rate (15 frames/s \rightarrow 13 cycles per frame)

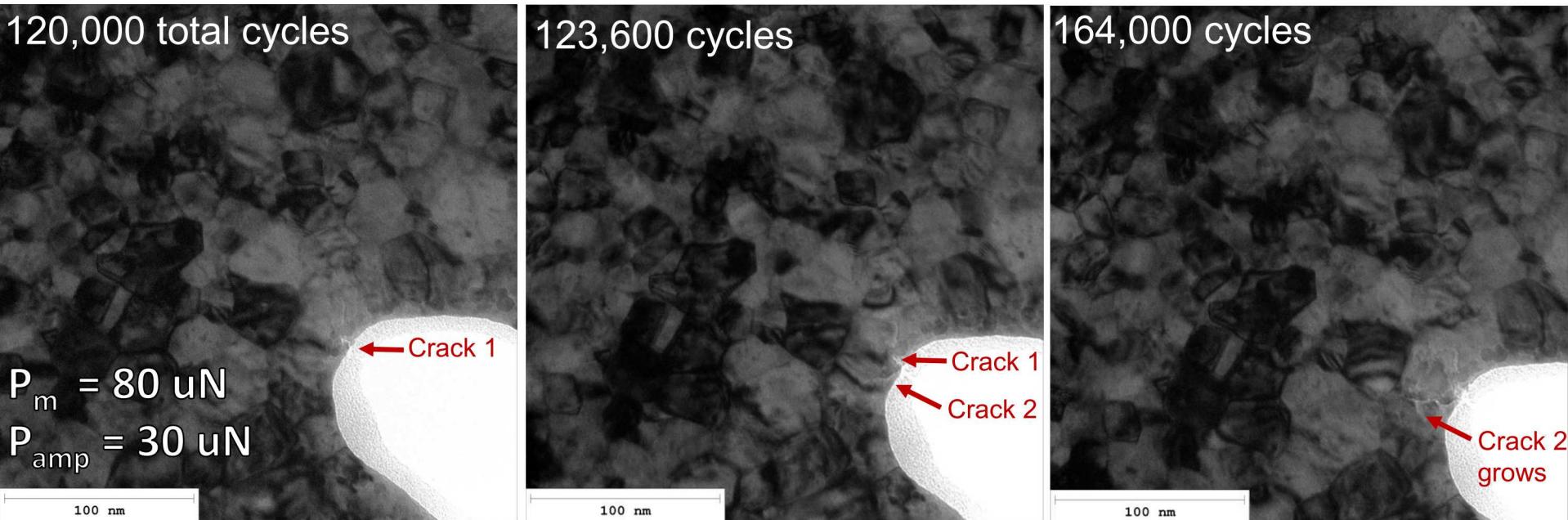
Advantages of PED coupled In-situ Experiments



- Ability to couple grain orientation and grain boundary misorientation with crack propagation
 - Feasible to track relative grain rotation or variation in GB misorientation under loading

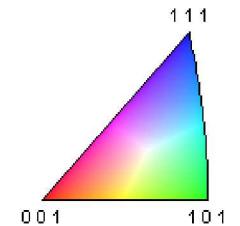
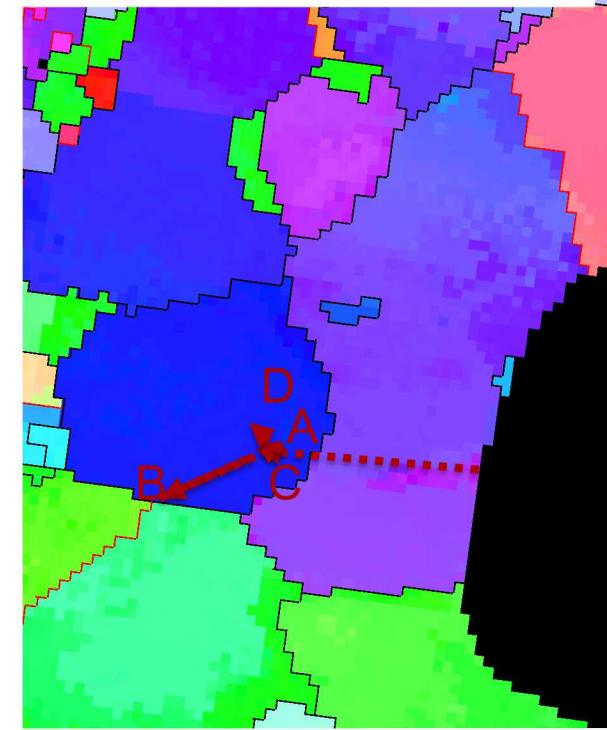
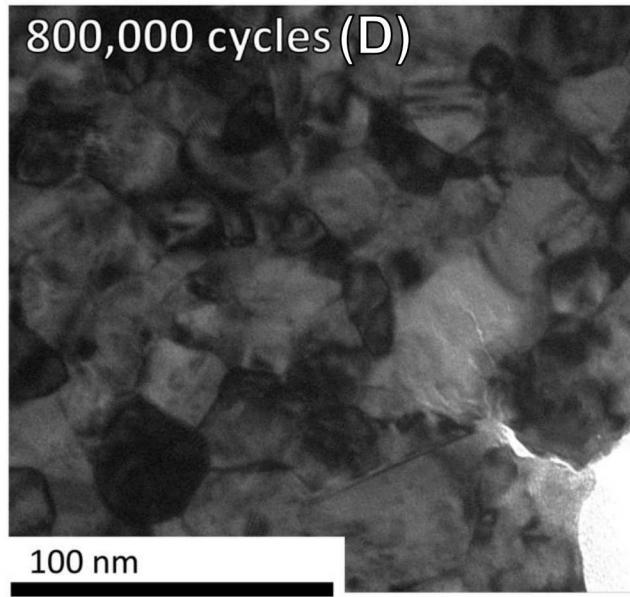
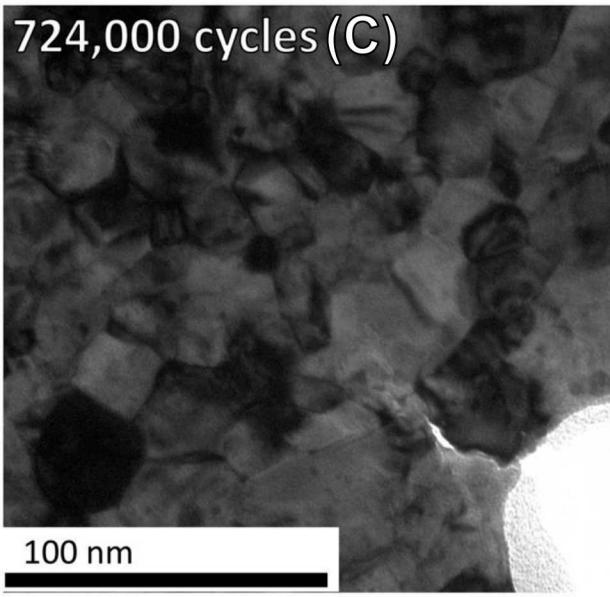
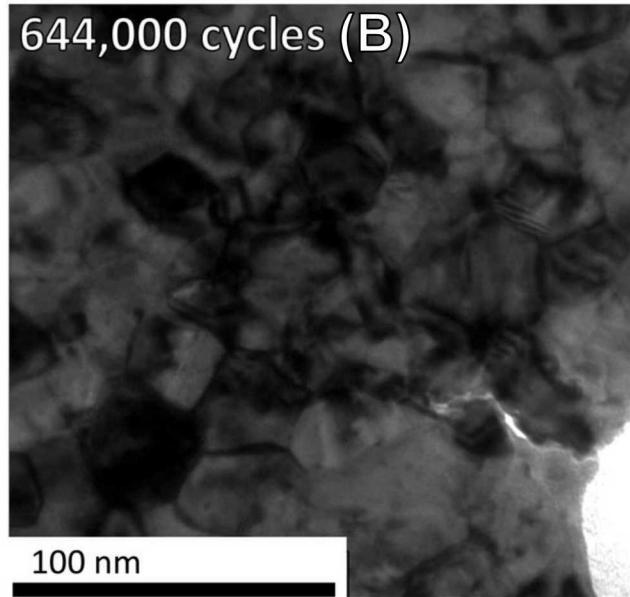
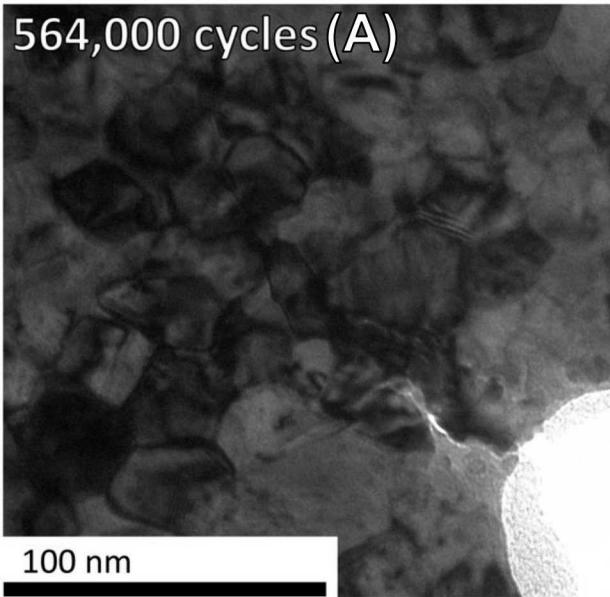
PED orientation maps pre-, intermediate, and post- in-situ mechanical test can assist in deconvoluting possible NC stress assisted grain growth

Crack Initiation at Notch



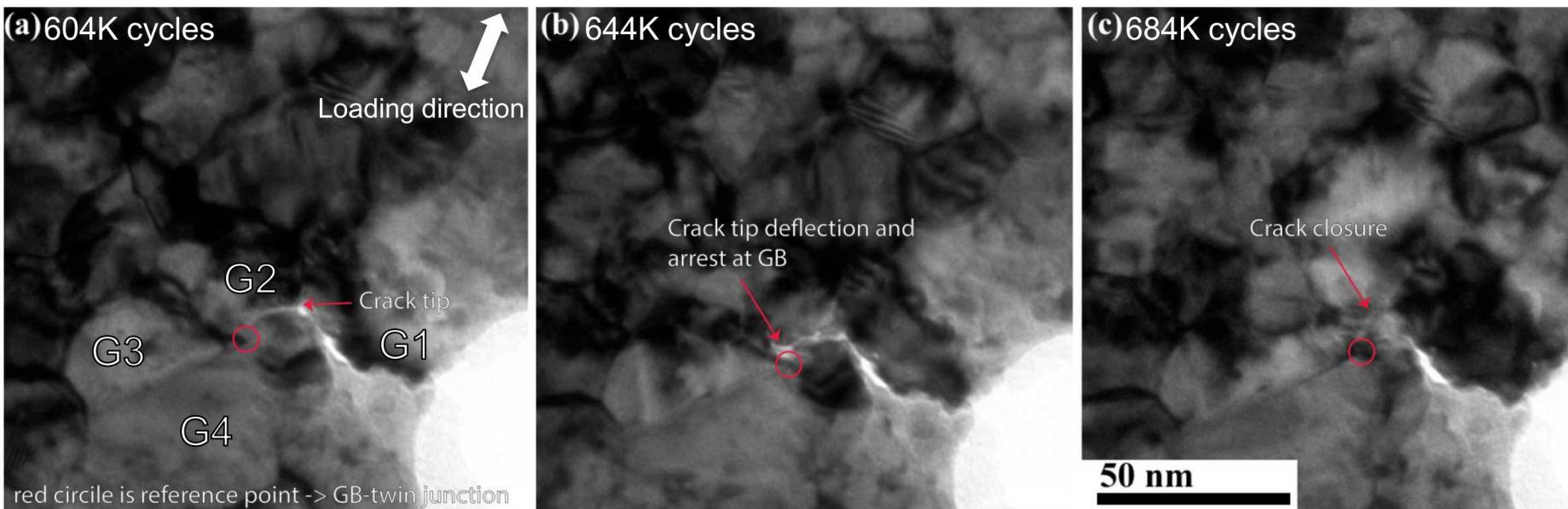
- Crack initiation and initial propagation at notch tip
- Second crack initiates at $\sim 90^\circ$ to first crack, both 45° to notch tip normal
- Intra-granular crack (crack #2) propagates until reaching initial grain boundary and is subsequently arrested

Crack Propagation, Closure, and Re-Direction

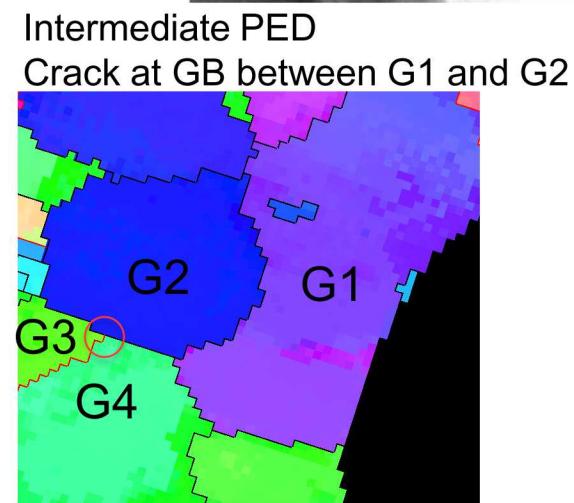


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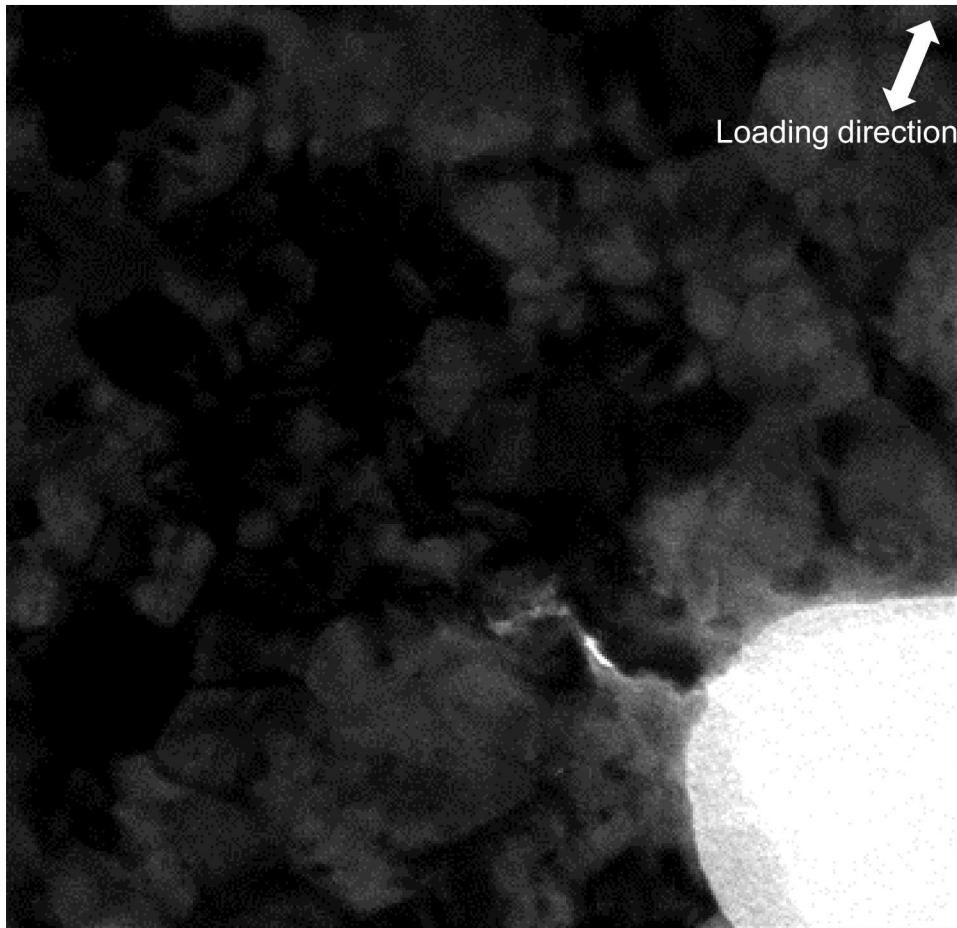
Fatigue crack closure: Is this crack healing?



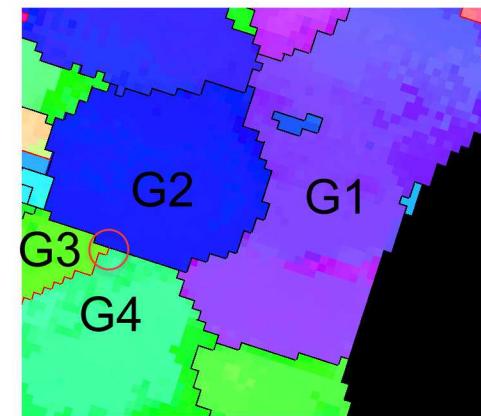
1. Fatigue crack propagates into Grain G2
2. In G2, significant crack deflection away from Mode I (normal to load)
 - Kinked or doubly-kinked crack deflection
3. Crack appears to be temporarily arrested at GB between G2 and G3
4. Next test (between 644K and 684K, crack appears to close (heal?)



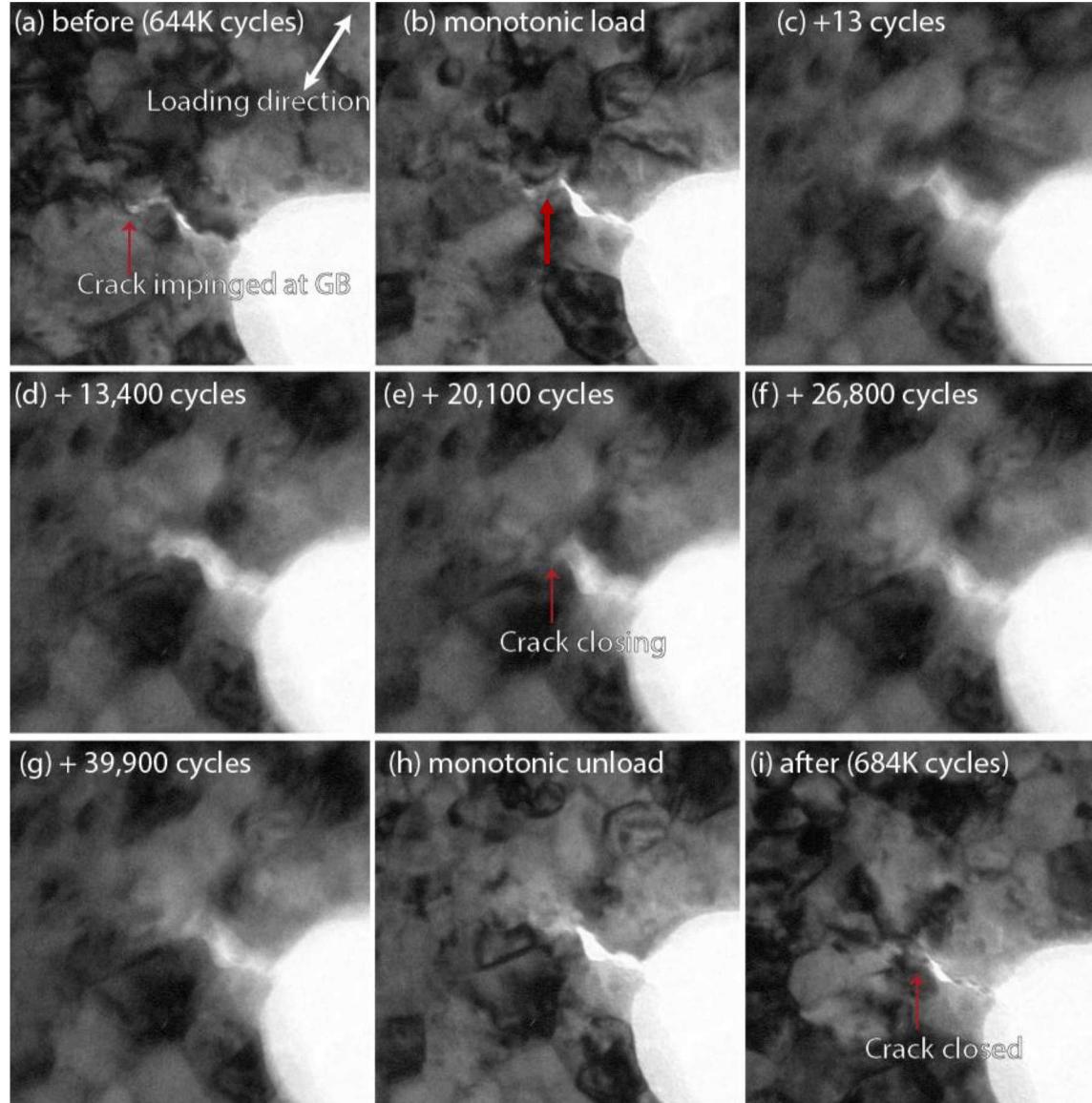
Fatigue Crack Healing: 40K Cycle Video



- 6X speed, 200 Hz loading 200 sec real time → 40K cycles
- Between 644K and 684K total cycles



Fatigue Crack Healing: Image Sequence

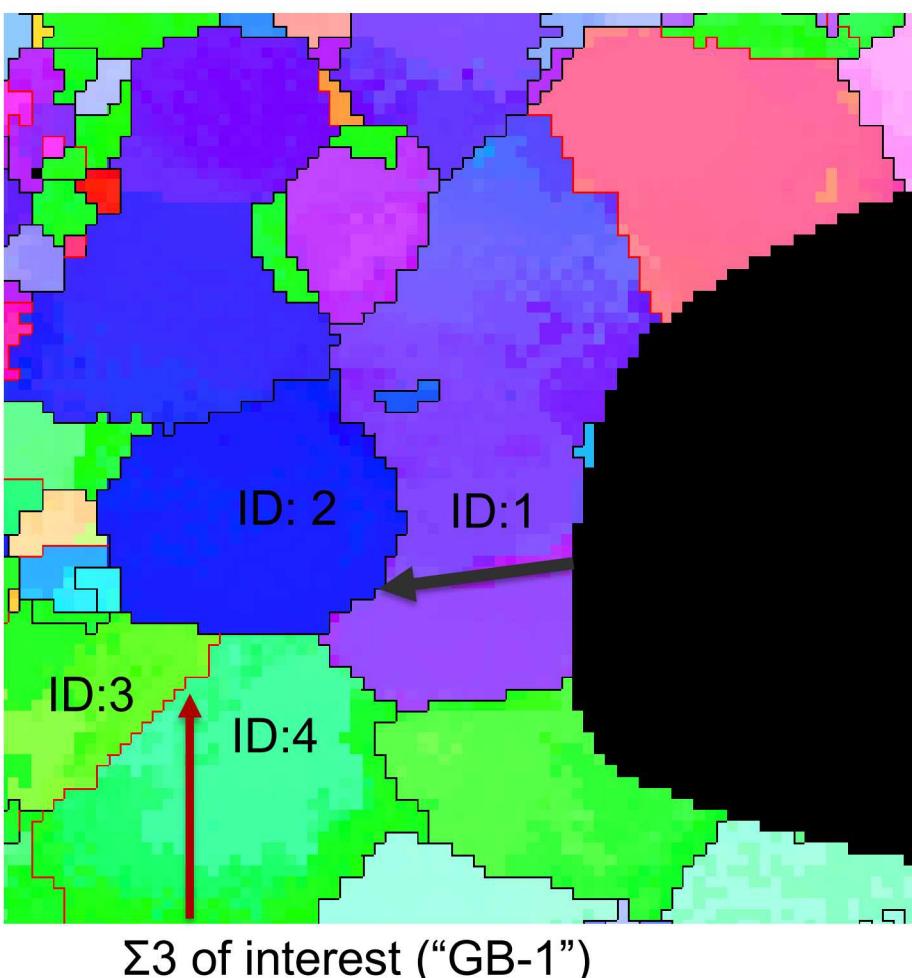


- Side-to-side contact on monotonic loading
- Contrast changes after closure effect
- Unloading – no indications of previous deflected crack

Crack Healing: Discussion

- Significant deflected crack in Grain G2 → transition to mix-mode local loading. Deflected crack propagates until reaching GB obstacle (GB_{2-3}). Following cyclic test (644K total cycles to 684K total cycles), crack closes, we consider this a partial crack healing event.
- The localized “crack closure” mechanism appears to similar to “cold welding”
- Evidence for “cold welding” in context of previous literature:
 - Noble Pt, in vacuum, same grain (very important for orientation attachment mechanism – low localized diffusion barrier for single atoms), loading condition shows that the local crack faces come in contact (sliding and compressive?)
 - Crack sides come in contact during the monotonic loading during the 644K cycle test

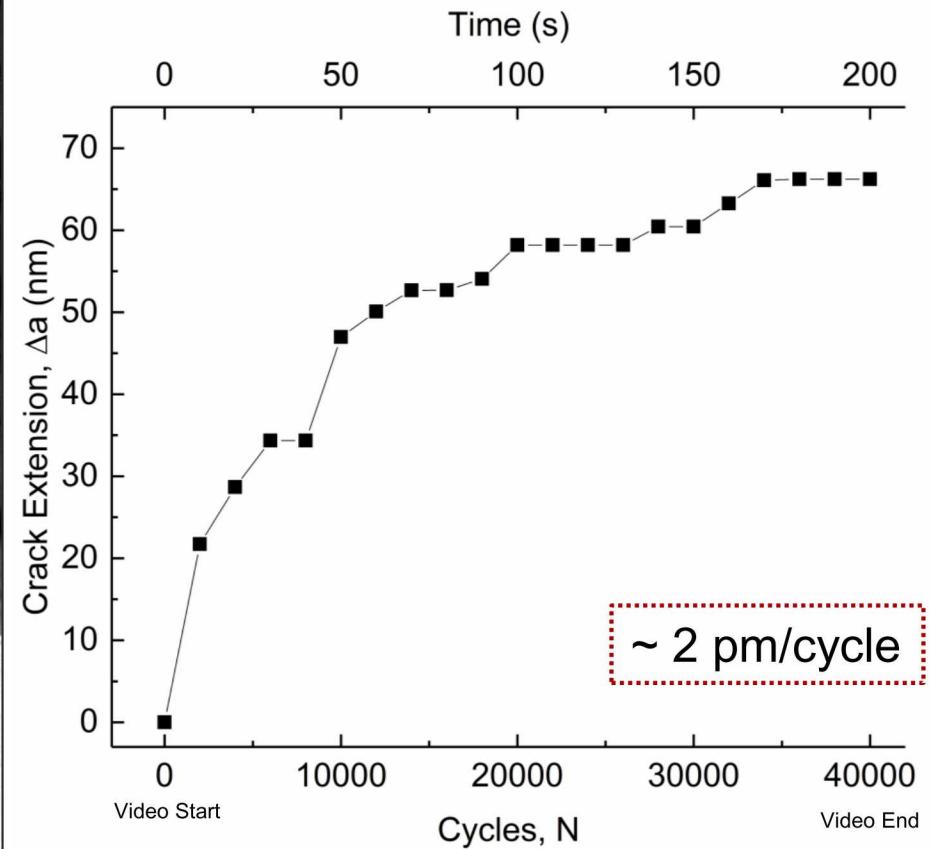
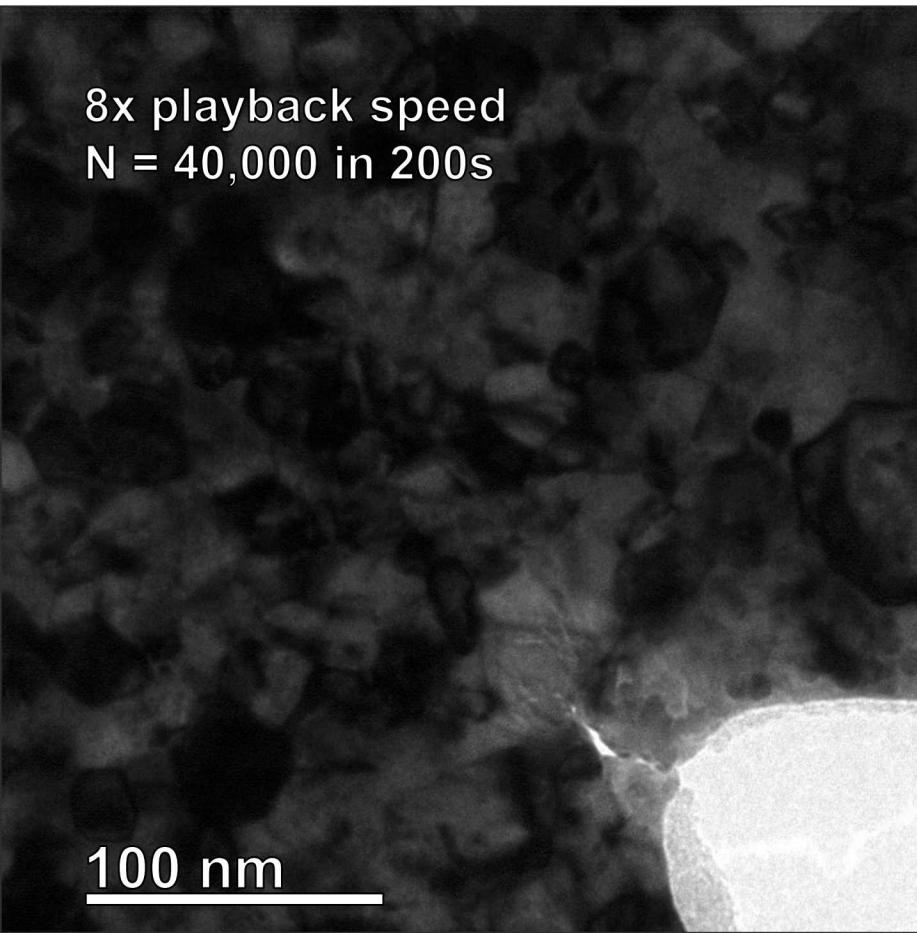
Cyclic Loading: GB Misorientation Changes



- Deformation and stress intensity of cyclic loaded crack tip induced modification (change in macroscopic misorientation) of the coherent $\Sigma 3$
- Decrease in $\Sigma 3$ coherency from nearly ideal twin misorientation to greater than 4° deviation likely associated:
 - Grain rotation and dislocation-GB impingement

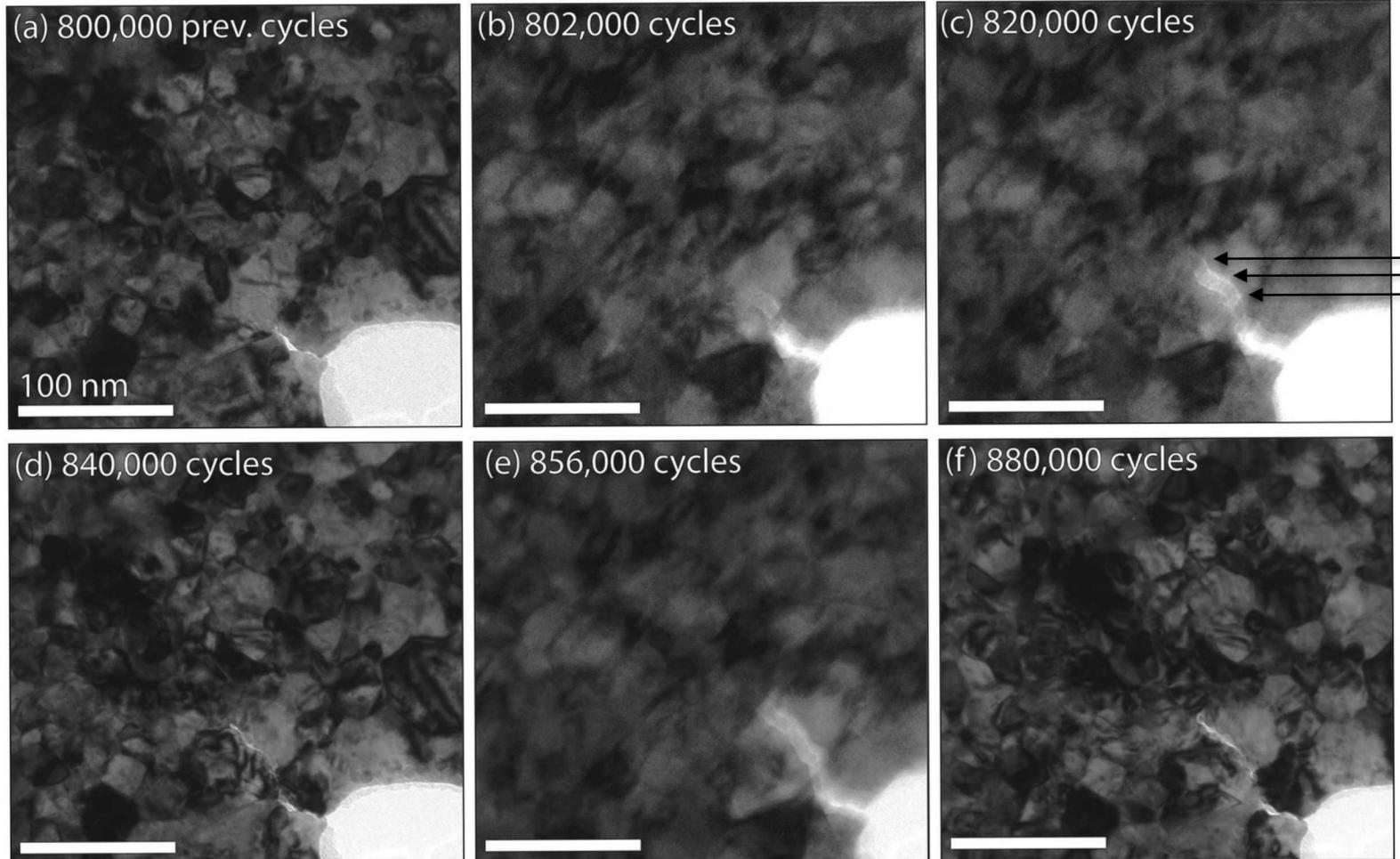
GB-1 (Twin Boundary $\Sigma 3$)	Misorientation	Deviation from Ideal $\Sigma 3$
Prior to Cyclic Loading	$59.9^\circ [1\ 1\ 1]$	0.8°
Crack Impinges GB at Grains 1-2	$56.9 [7\ 7\ 6]$	4.9°

Cyclic loading: transgranular crack propagation



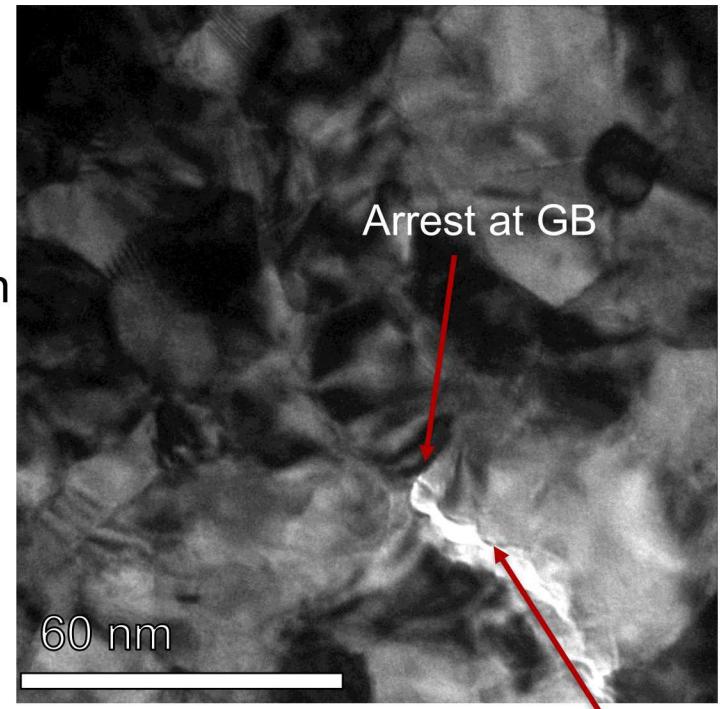
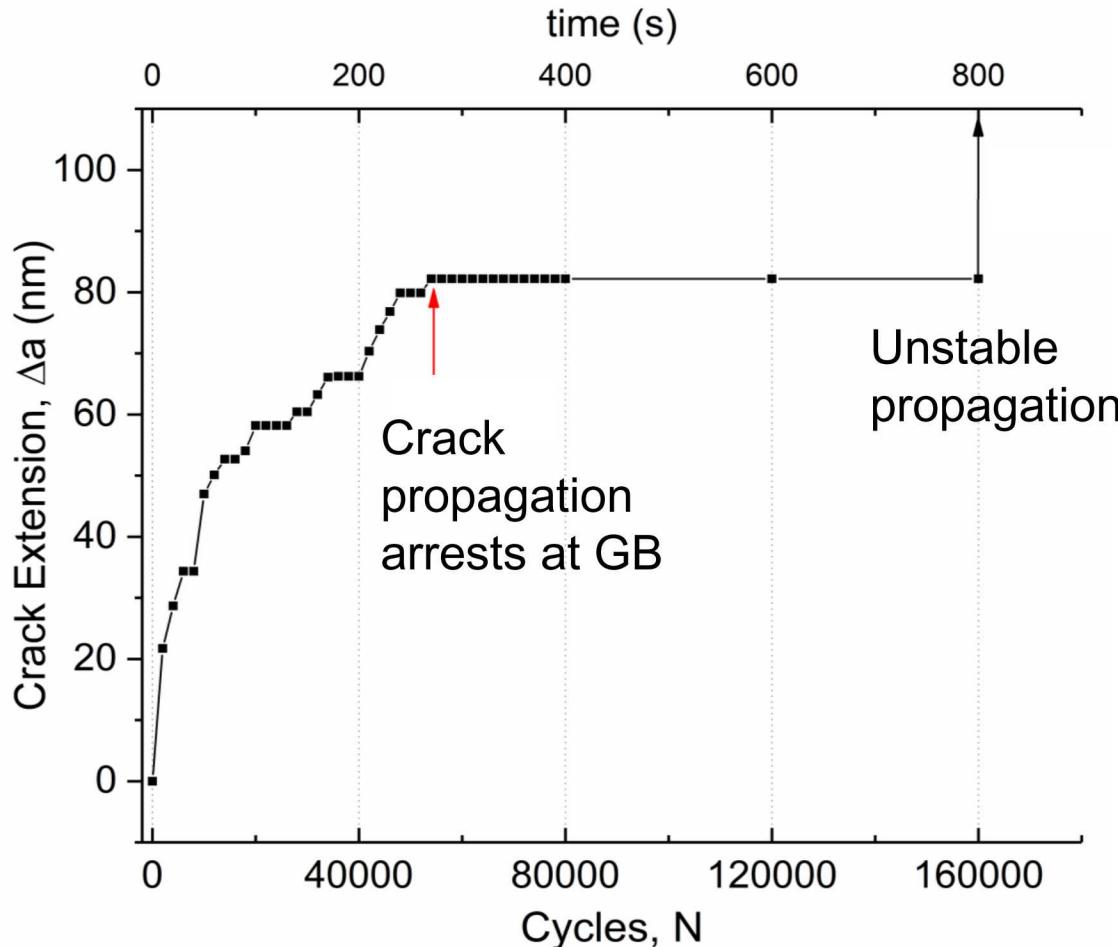
- Mean load: 135 uN; Amplitude load: 35 uN
- 200 Hz, 200s test (15 fps 1k x 1k camera)
- $da/dN = 1.7 \times 10^{12} \text{ m/cycle}$
- Non-linear crack extension rate
- Crack propagation path changes “direction”

Fatigue crack propagation and arrest



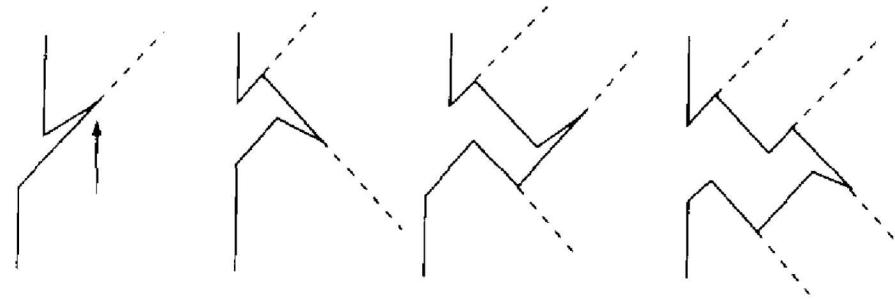
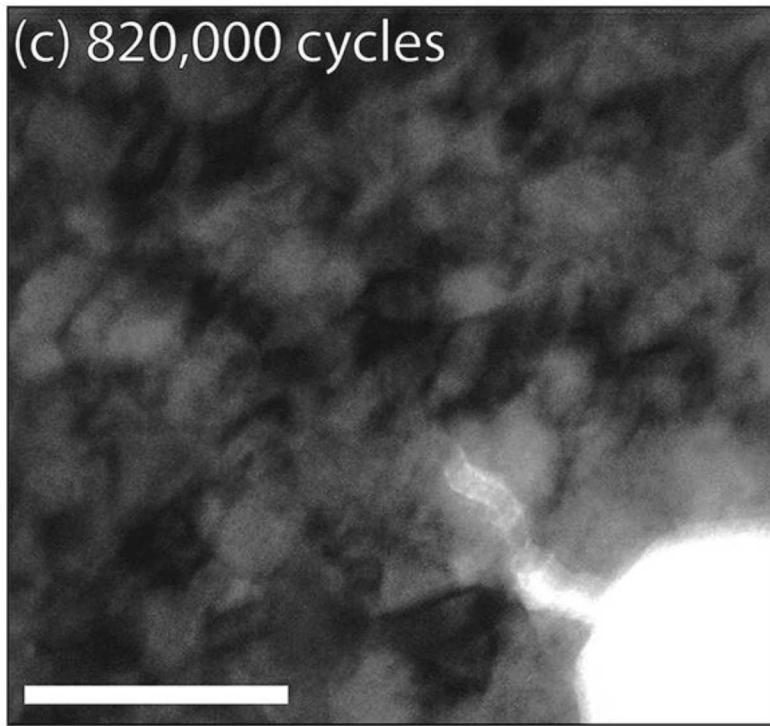
- Rapid propagation – transgranular between $N = 800K$ to $\sim 854K$
- After $854K$ cycles, cyclic loading crack impinges grain boundary – no further propagation
- Transgranular crack propagation non-linear

Fatigue crack propagation and arrest



- Rapid propagation – intragranular between $N = 800K$ to $\sim 854K$
- After 854K cycles, cyclic loading crack impinges grain boundary – no further propagation for addition $\sim 106K$ cycles
- Transgranular crack propagation non-linear: “serpentine fashion”

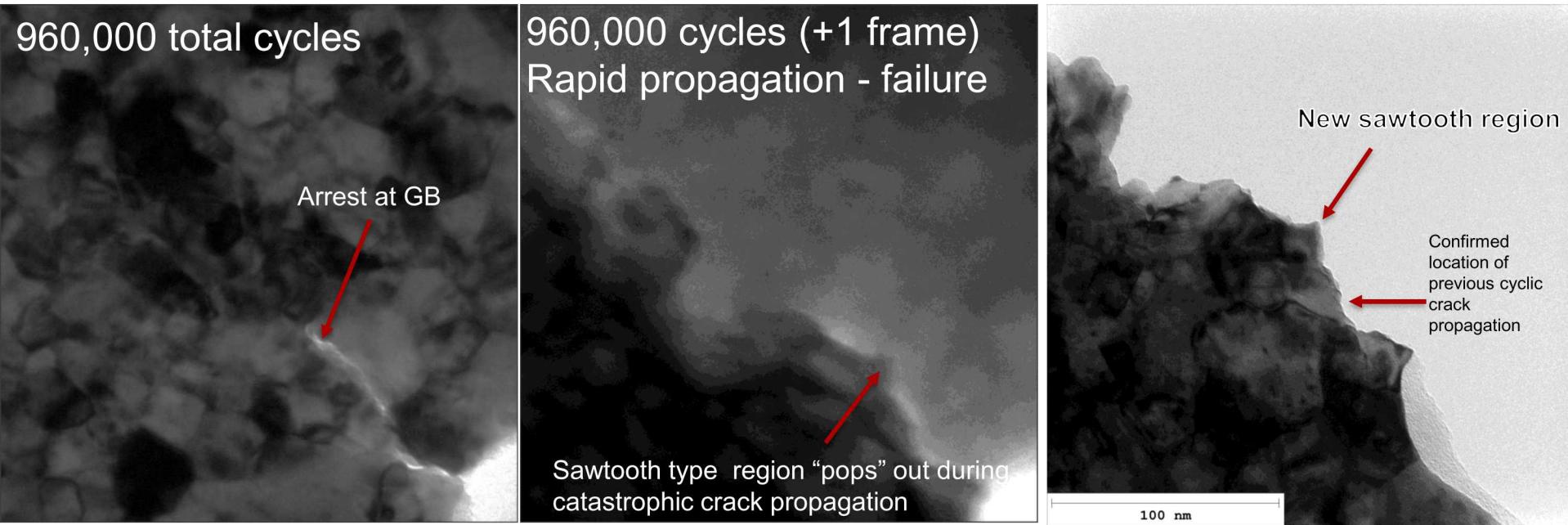
Transgranular crack propagation: non-linear



Ohr, Mat Sci & Eng 72
(1985) 1-35

- Classic in-situ tensile straining work by Ohr and colleagues observe zig-zag crack propagation → associated with emission of dislocations on alternating slip planes
- Non-uniform “fatigue” crack propagation observed here transgranular has similar alternating crack propagation fronts – possible mechanisms still under review
- PED data provides opportunity to associate with crystal orientation (and subsequent slip plane normals)

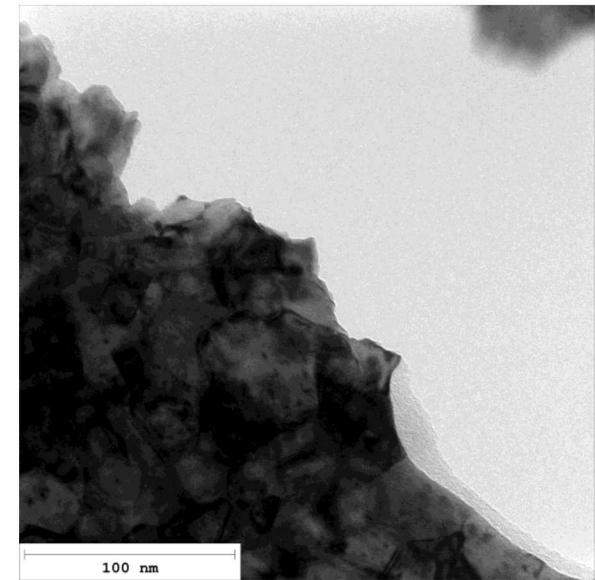
Unstable propagation and failure



- Unstable propagation of crack occurred just under 1M total cycles
- Sample failed on initial ramp ($\sim 100 \text{ uN}$) to monotonic mean load (135 uN) at 960,000 cycles
- Fracture surface consistent with location of previous fatigue crack propagation
- Indications of “sawtooth” intra-grain plasticity during this rapid failure mechanism

Discussion and Conclusions:

- PI-95 in tension-tension “fatigue” mode (nanoDMA) provide wealth of new in-situ TEM mechanical testing potential
 - Ideally coupled with ACOM TEM or other methods to enhance analysis
- Dual crack tip initiation observed at notch
- **Cyclic load induced crack propagation is effectively arrested at GBs** – indications of effectiveness of NC materials under fatigue
- **~ 2 pm/cycle crack growth rate (dA/dN)!**
 - Non-uniform, non-straight crack propagation – “zig-zag” motion
- **Localized deformation:** Coupled ACOM-TEM indicates grain rotation, dislocation based plasticity active → **clear change in $\Sigma 3$ coherency in front of crack tip**
- **Failure associated with classical in-situ TEM mechanical “saw-tooth” plasticity**

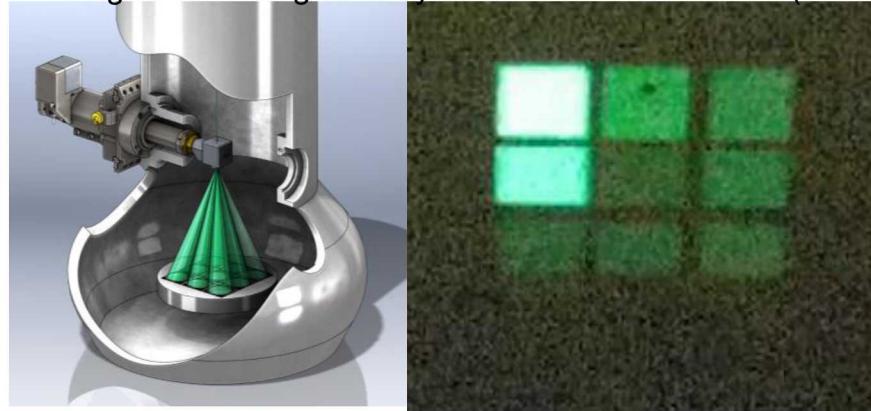


Saw-tooth classically explained by local plastic flow – (e.g. Wilsdorf and Kumar et al. Acta 2003)

Future In-Situ Mechanical Testing Directions at I³TEM Facility



Images from Integrated Dynamic Electron Solutions (IDES):

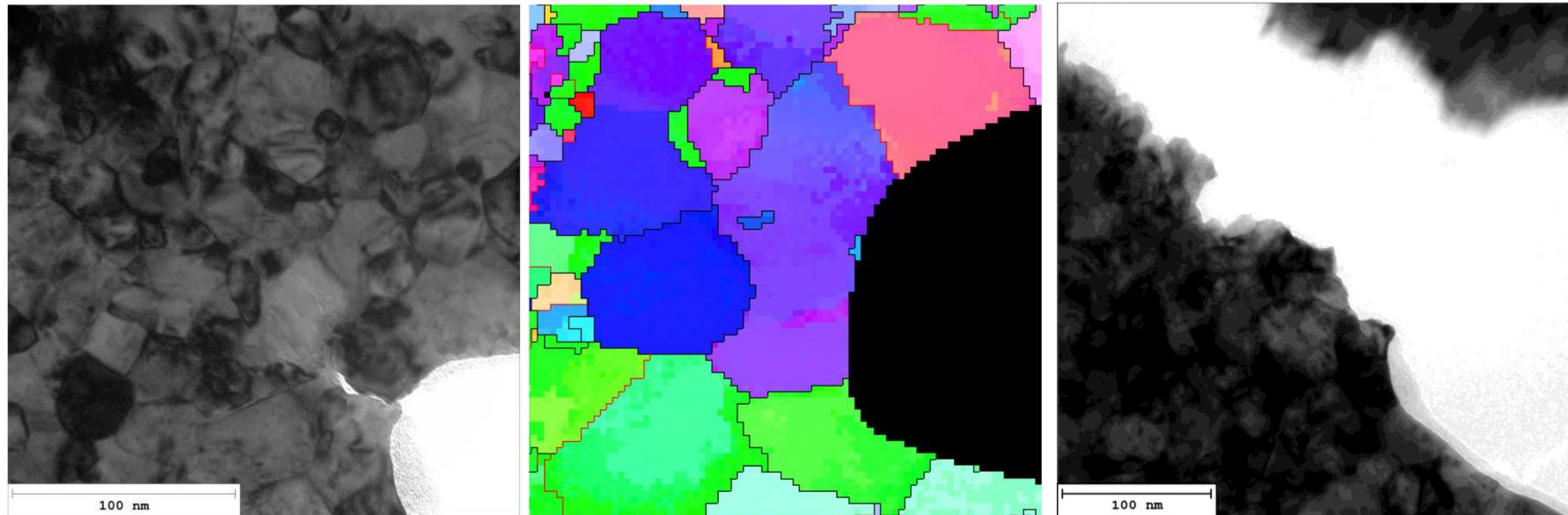


- High cycle fatigue – more detailed quantification of grain growth
 - Other model alloys, multi-layers, alloying effects (e.g. Pt-10Au vs. Pt)
- Creep, radiation-induced creep
- TEM notched three point bend
- Under development capabilities:
 - DTEM and/or movie mode with crack propagation for improved temporal resolution under high Hz cyclic loading

Combining the precision of Hysitron's Pico-indenter with harsh environments capable in Sandia's In-situ Ion Irradiation TEM a wealth of previously impossible experiments are now feasible.

Summary:

On-going efforts to combining PED/ACOM with quantitative mechanical testing provides new correlations between structure-property relationships with unprecedented orientation and mechanical property information.

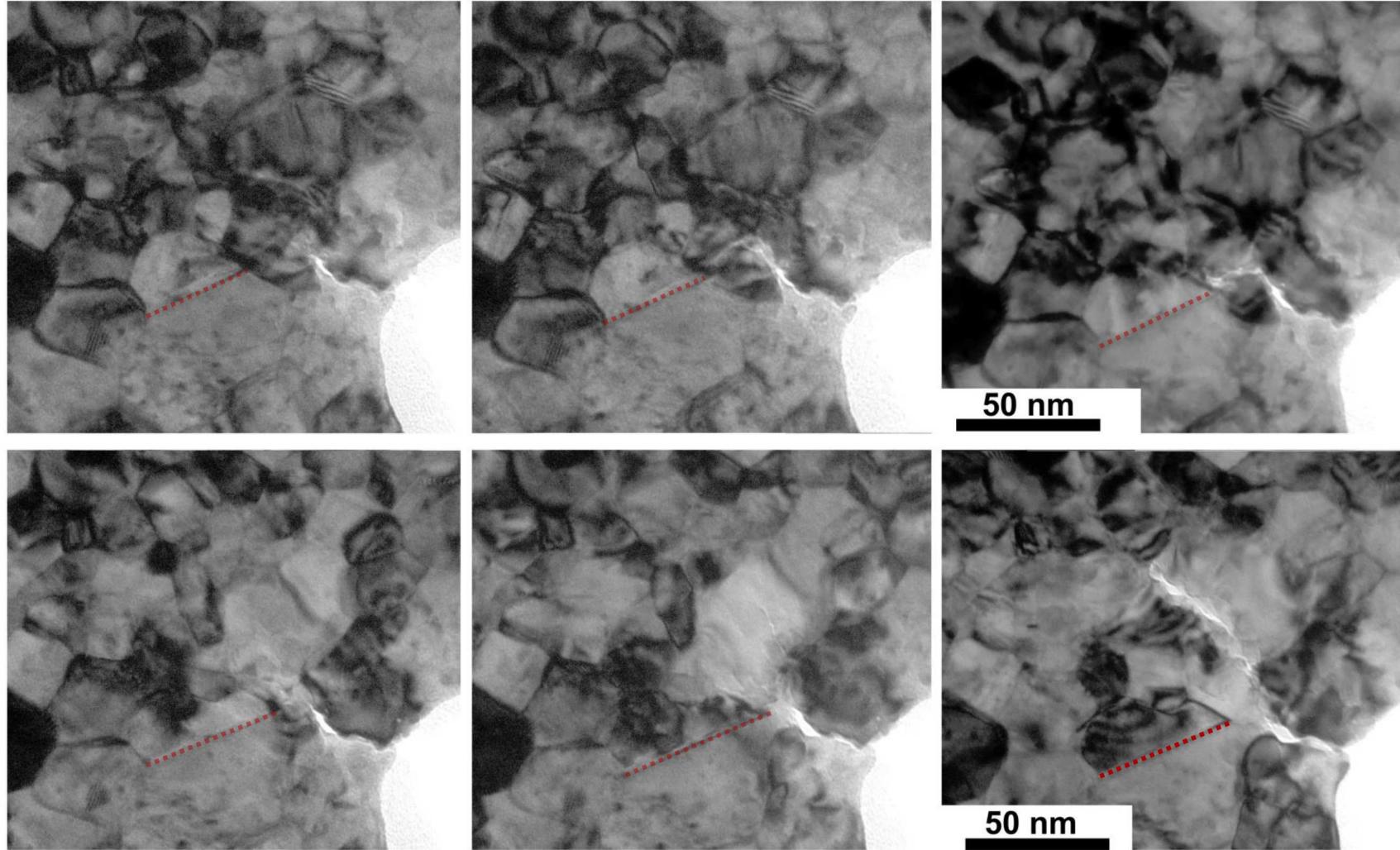


Collaborators and Acknowledgements: B.L. Boyce, N. Heckman, D. Adams (Pt thin film deposition), Sandia National Laboratories.

Work performed by C.M.B and K.H. was fully supported by the Division of Materials Science and Engineering, Office of Basic Energy Sciences, U.S. Department of Energy. FIB sample preparation was performed, in part, at the Center for Integrated Nanotechnologies, an Office of Science User Facility operated for the U.S. Department of Energy (DOE) Office of Science.

Extra slides beyond this point

Local Twin “Growth” and Elongation



Local Twin “Growth” and Elongation

